REV	ECO	DATE		
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001	54616	4/29/2013		
002	55642	4/28/2015		

NOTES: UNLESS OTHERWISE SPECIFIED.

- 1. MATERIALS AND PLATING:
 - 1.1 BODY: (142-0781-881) GOLD PLATED BRASS (142-0781-882) GOLD PLATED BRASS
 - 1.2 INSULATOR: (142-0781-881) TEFLON
 - (142-0781-882) TEFLON
 - 1.3 CENTER CONTACT: (142-0781-881) GOLD PLATED BERYLLIUM COPPER
 - (142-0781-882) GOLD PLATED BERYLLIUM COPPER EXPOSED CENTER PIN PRE-TINNED
 - WITH SAC 305 SOLDER (96.5Sn/3.0Ag/.5Cu)
- 2. ELECTRICAL SPECIFICATIONS:
 - 2.1 IMPEDANCE: 50 OHMS
 - 2.2 FREQUENCY RANGE: 0-26.5 GHz
 - 2.3 VSWR: 1.05+.02F(GHz) MAX AT 0-18 GHz, TYPICALLY < 1.50 AT 18-26.5 GHz
 - 2.4 WORKING VOLTAGE: 170 VRMS MAX AT SEA LEVEL
 - 2.5 DIELECTRIC WITHSTANDING VOLTAGE: 500 VRMS MIN AT SEAL LEVEL
 - 2.6 INSULATION RESISTANCE: 1000 MEGOHMS MIN
- 2.7 CONTACT RESISTANCE: CENTER CONTACT INITIAL 3.0 MILLIOHMS MAX,
 AFTER ENVIRONMENTAL 4.0 MILLIOHMS MAX

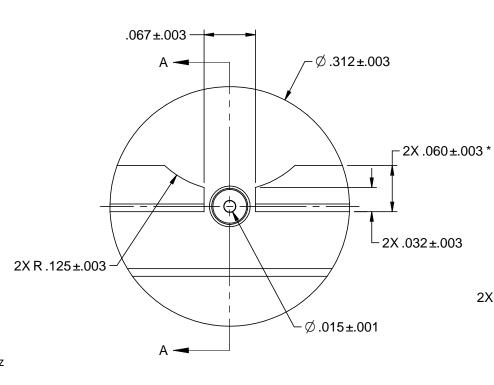
OUTER CONDUCTOR - INITIAL 2.0 MILLIOHMS MAX

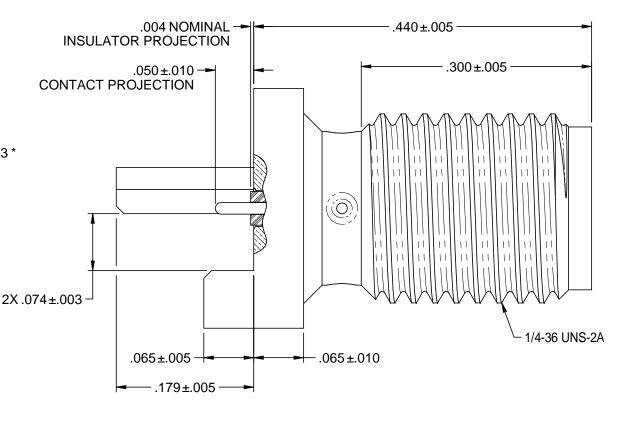
- AFTER ENVIRONMENTAL N/A 2.8 CORONA LEVEL: 125 VOLTS MIN AT 70,000 FEET
- 2.9 INSERTION LOSS: N/A (DEPENDANT UPON APPLICATION)
- 2.10 RF HIGH POTENTIAL WITHSTANDING VOLTAGE: 335 VRMS MIN AT 4 AND 7 MHz
- 3. MECHANICAL SPECIFICATIONS:
- 3.1 ENGAGEMENT/DISENGAGEMENT TORQUE: 2 INCH POUNDS MAX
- 3.2 MATING TORQUE: 7-10 INCH POUNDS WHEN SUPPORTED WITH WRENCH
- *8 INCH-POUNDS MAX UNSUPPORTED
- 3.3 CONTACT RETENTION: 6 LBS MIN AXIAL FORCE
 - 4 OZ-IN MIN RADIAL TORQUE
- 3.4 DURABLITY: 500 CYCLES MIN
- 4. ENVIRONMENTAL SPECIFICATIONS:
- 4.1 (MEETS OR EXCEEDS THE APPLICABLE PARAGRAPH OF MIL-PRF-39012)
- 4.2 THERMAL SHOCK: MIL-STS-202, METHOD 107, CONDITION B,
- 4.3 EXCEPT 115°C HIGH TEMP
- 4.5 OPERATING TEMPERATURE: -65°C TO 165°C
- 4.6 CORROSION: MIL-STD-202, METHOD 101, CONDITION B
- 4.7 SHOCK: MIL-STD-202, METHOD 213, CONDITION I
- 4.8 VIBERATION: MIL-STD-202, METHOD 204, CONDITION D
- 4.9 MOISTURE RESISTANCE: MIL-STD-202, METHOD 106
- 5. ALL HOLES PLATED THRU ENTIRE CIRCUIT BOARD STACKUP.
- 6 HOLE PATTERNS SYMMETRICAL ABOUT CENTER OF CPW TRACE.
- 7. FOR OPTIMUM CIRCUIT BOARD HIGH FREQUENCY PROFORMANCE:
 - A. MAINTAIN SOLID GROUND PLANE BELOW HIGH FREQUENCY SUBSTRATE.
 - B. CONTROL PULLBACK OF TRACE AND GROUND FROM BOARD EDGE.
 - C. CONTINUE GROUNDED COPLANAR LINE BEYOND GROUND PADS.
 - D. PLACE 16 MIL DIA GROUND VIAS ON BOTH SIDES OF COPLANAR WAVEGUIDE LINE AT 50 MIL INTERVALS ALONG ENTIRE LENGTH.
 - E. IMMERSION GOLD PLATE (ENIG) ALL CONDUCTORS PER IPC-4552.

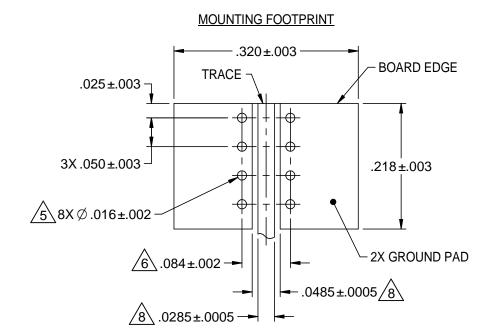
REFERENCE DIMENSIONS FOR 50 OHM GROUNDED CPW LINE, USING ROGERS R04003, 16 MIL HIGH FREQUENCY CIRCUIT BOARD SUBSTRATE:

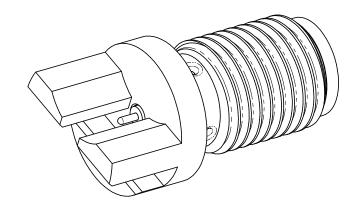
TRACE WIDTH - 28.5 MILS GROUND GAPS - 10 MILS

CONDUCTOR THICKNESS - 1.4 MIL (INCLUDES PLATING)









cinch	Model No. 142-0781-881/890		Johnson				
CONNECTIVITY SOLUTIONS a bel group	RoHS☑		Title: HIGH FREQ END LAUNCH SMA BKH			HD	
This PROPRIETARY Document is property of Emerson Network Power Connectivity Solutions. It is confidential in nature.	UNLESS OTHERWISE SPECIFIED	A	JACK ASSEMBLY, EDGE MOUNT, 15 MIL PI Drawing No. Rev				Rev.
non-transferable, and issued with the clear understanding that it is not traced or copied without permission and is returnable upon demand.		142-0781-881/890			002		
INTERPRET DRAWING IN ACCORDANCE WITH ASME Y14.5-2009.		Date: 5/10/2013	Size R	DO NOT SCALE	Workmanship Std: NONF	Sheet	1 of 1

Mouser Electronics

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